

## BM50 Series

# **0.35mm** Pitch, **0.6mm** Stacking Height, **15A** Rated Current, Power/Signal Hybrid FPC-to-Board Connector



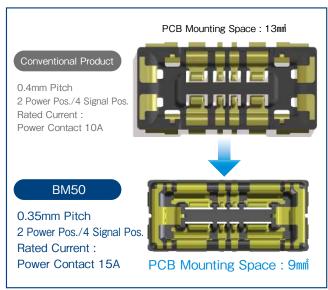


## **Features**

## Space-saving Design with 15A Rated Current

The power contact supports 15A per position and the signal contact supports 0.3A per position for high power supply capability.

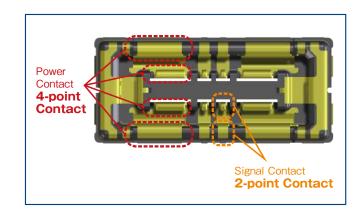
Additionally, the BM50U has a space-saving design that minimizes connector size.



Increase the Rated Current from 10A to 15A While Achieving Space Reduction (30% Decrease in PCB Mounting Space)

## 2. High Contact Reliability

Multi-point contact design with 4-point power contact and 2-point signal contact for stable connection.



# 3. Compact with High Extraction Force

The original lock design ensures high extraction force and prevents unmating due to impact.

## 4. Halogen-free

No chlorine or bromine exceeding the standard values are used in this connector.

In accordance with IEC 61249-2-21  $\mbox{Br}$  : 900ppm max., CI : 900ppm max.,

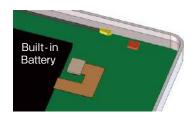
Br+Cl: 1500ppm max.

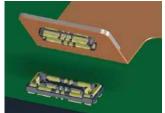


## **Applications**

Devices that require low-profile, compact design such as smartphones, wearable terminals and tablet PCs.

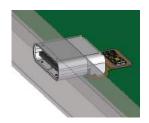
## Battery Connection



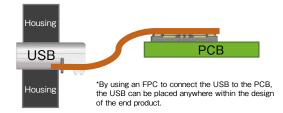


- -Space-saving
- -High Current Capacity

## •USB Connection



- -Compatible with USB Power Delivery
- -Easy to Replace USB Connector
- -No Need for Main Board Height Alignment\*



## **Product Specifications**

Rated Current	Signal Contact : 0.3A	Operating Temperature (Note 1)	-55 to +85℃
	Power Contact : 15A	Operating Humidity Range (Note 2)	90% RH Max.
Rated Voltage	60V AC/DC	Storage Temperature (Note 3)	-10 to +60℃
		Storage Humidity Range (Note 2)(Note 3)	90% RH Max.

Item	Specifications	Conditions
Contact Resistance	Signal Contact $30m\Omega$ , Power Contact $5m\Omega$	Measured at 20mV AC, 1kHz, and 1mA
Insulation Resistance	1000 MΩ Min.	Measured at 100V DC
Withstanding Voltage	No flashover or dielectric breakdown	150V AC for 1 min.
Mating Durability	Contact Resistance : Signal Contact $30m \Omega$ Power Contact $5m \Omega$	10 cycles
Vibration Resistance	No electrical discontinuity of 1 $\mu$ s or more.	Frequency: 10 to 55Hz, half amplitude of 0.75mm, 10 cycles in each of 3 axis directions for 5 minutes/cycle
Humidity Resistance	Contact Resistance : Signal Contact $30m \Omega$ Power Contact $5m \Omega$ Insulation Resistance : $1000M \Omega$ Min.	Left for 96 hours at a temperature of 40 $\pm$ 2°C and a humidity range from 90 to 95%
Temperature Cycle	Contact Resistance : Signal Contact $30m \Omega$ Power Contact $5m \Omega$ Insulation Resistance : $1000M \Omega$ Min.	-55°C for 30 minutes → 85 for 30 minutes, 5 cycles (Tank transfer time: within 2 to 3 min.)
Solder Heat Resistance	No dissolution or resin melting that will affect performance.	Reflow: At recommended temperature profile Hand solder: Solder iron temperature of 350°C for 3 seconds max.

Note 1: Includes temperature rise caused by current flow.

Note 2 : Use without condensation.

Note  ${\bf 3}$ : Storage refers to long-term storage of unused items before they are mounted on the PCB.

Operating temperature and humidity range apply when the product is not powered after PCB mounting and when temporarily stored during transportation.



## Material/Finish

Part	Component	Material	Finish	UL Standard	
	Insulator	LCP	Black	UL94V-0	
Header Receptacle	Signal Contact	Copper Alloy	Gold Plated	-	
. recoptable	Power Contact	Copper Alloy	Gold Plated	-	

## **Product Number Structure**

Refer to the chart below when determining the product specifications from the product number. Please select from the product numbers listed in this catalog when placing orders.

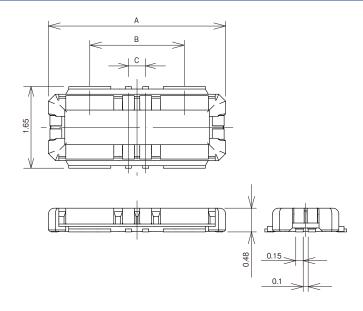
Header/Receptacle

 $\underbrace{\mathsf{BM}}_{\bullet} \, \underbrace{\mathsf{50U}}_{\bullet} \, \cdot \underbrace{\mathsf{4}}_{\bullet} \, \underbrace{\mathsf{DP}}_{\bullet} \, / \underbrace{\mathsf{2}}_{\bullet} \, \cdot \underbrace{\mathsf{0.35}}_{\bullet} \, \underbrace{\mathsf{V}}_{\bullet} \, \underbrace{(51)}_{\bullet}$ 

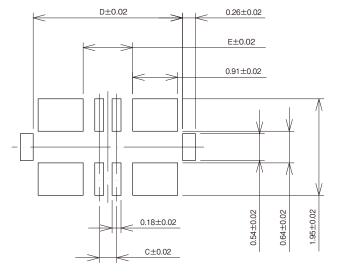
0	Series Name	ВМ	6	No. of Power Contacts	2pos.			
2	Series No.	50U	6	Contact Pitch	0.35mm			
3	No. of Signal Contacts	4pos.	7	Terminal Design	V : Straight SMT			
4	Connector Type	DP : Header DS : Receptacle		Plating	(51) : Gold Plating Thickness 0.05 μ m Embossed Packaging			
			8	Specifications and Packaging	(20,000pcs per reel) (53): Gold Plating Thickness 0.05 μ m Embossed Packaging (1,000pcs per reel)			

## Header

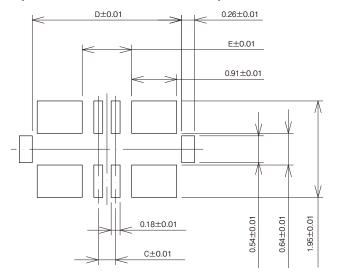




## Recommended PCB Layout



## Recommended Metal Mask Dimensions (Mask Thickness: 0.08mm)



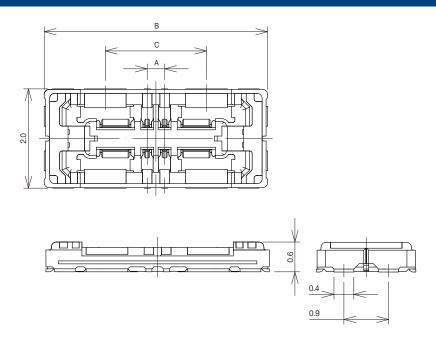
Unit: mm

Part No.	HRS No.	No. of Signal Contact	Pos. Power Contact	А	В	С	D	E	Purchase Unit (##):(51)	Purchase Unit (##):(53)
BM50U-4DP/2-0.35V(##)	CL0480-0670-0-##	4	2	3.58	1.91	0.35	3.02	1.00	20,000pcs per reel	1,000pcs per reel

Note: This connector has no polarity.



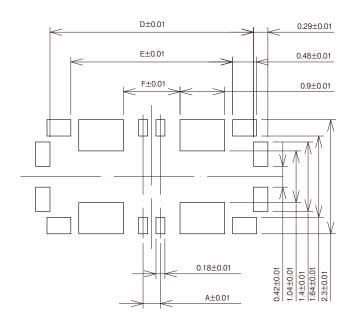




## Recommended PCB Layout

# D±0.02 E±0.02 O.48±0.02 O.9±0.02 O.9±0.02 A±0.02 O.78±0.02 O.78±0.02

## Recommended Metal Mask Dimensions (Mask Thickness: 0.08mm)



Unit : mm

Part No.	HRS No.	No. of Signal Contact	Pos. Power Contact	А	В	С	D	E	F	Purchase Unit (##):(51)	Purchase Unit (##):(53)
BM50U-4DS/2-0.35V(##)	CL0480-0671-0-##	4	2	0.35	4.50	2.04	4.10	3.26	1.14	20,000pcs per reel	1,000pcs per reel

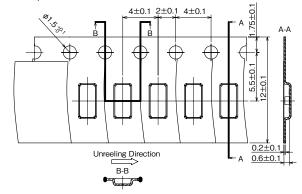
Note: This connector has no polarity.

## **Packaging Specifications Diagram**

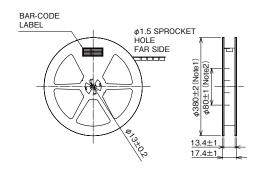
IEC 60286-3, JIS C 0806 Compliant

## Header

## Embossed Tape Dimensions



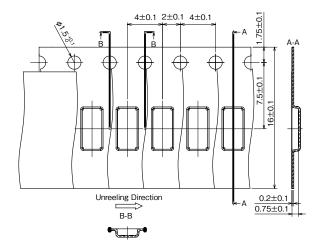
## Reel Dimensions



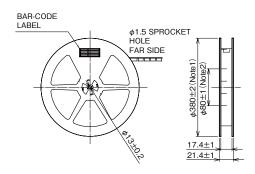
Note1:The (53) specification is  $\phi$ 180 $\pm$ 2. Note2:The (53) specification is  $\phi$ 60 $\pm$ 1.

## Receptacle

## Embossed Tape Dimensions



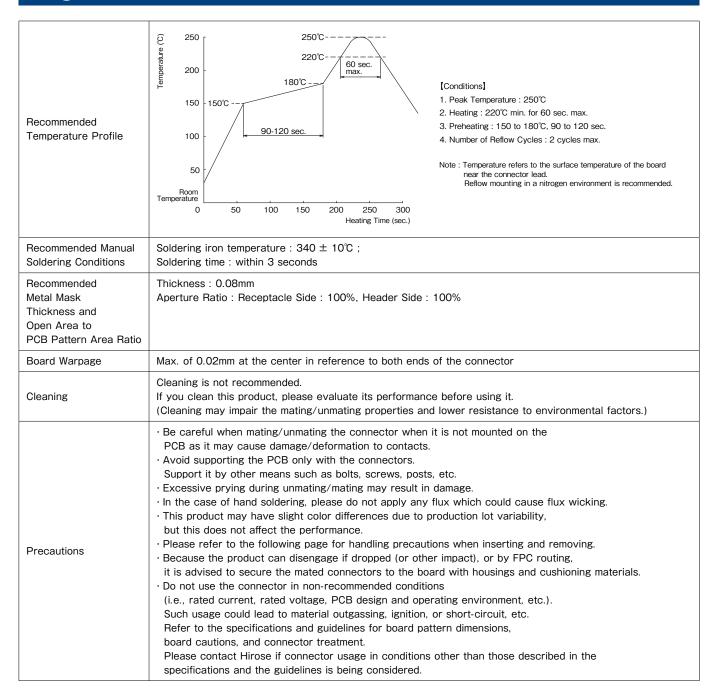
## Reel Dimensions



Note1:The (53) specification is  $\phi$ 180±2. Note2:The (53) specification is  $\phi$ 60±1.



## **Usage Precautions**

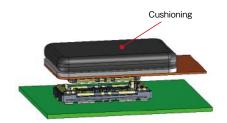


## **Connector Handling Precautions**

## [Mating Disengagement Prevention]

Please use cushioning.

This connector may come off due to impact such as dropping. Cushioning should be large enough to cover the entire connector.



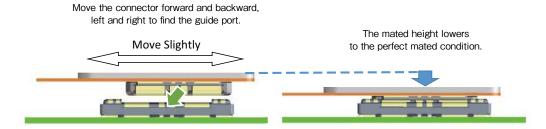
## [Mating Method]

1. Locate the guide port and align.

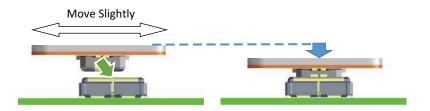
This product has a guide rib on the header to ensure proper engagement. Align the connector so that it is in this position.



2. Once aligned, the connector engages. You can feel the mated height of the connector lower.



3.In the engaged state, the connectors are parallel to each other, and the connectors cannot move forward, backward, left, or right. Complete mating from this state.



4. Check that mating is completed.

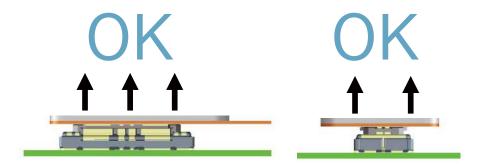
If one side is floating, or if it is mated at a diagonal, remove and re-mate.



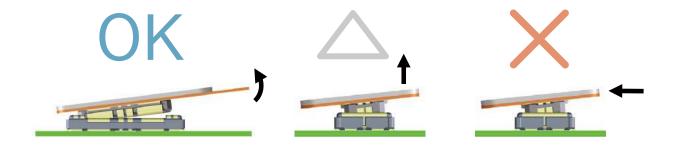
## [Handling Precautions for Connector Removal]

1. When removing the connector, it is preferable to pull it out in the upward direction from the connector mounting surface.

However, when removing the FPC from the circuit board it becomes more difficult to remove it vertically with higher pin counts and thin FPCs.



2. If difficult to remove, extract the connector diagonally in the direction of the pitch. Note that removal from the widthwise side will apply a large load to the contacts. When removing from the width direction, pull the end of the FPC in the upward direction. (When a force is applied in the horizontal direction, a large load is applied to the contact.)

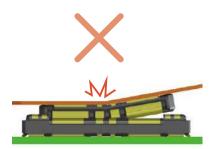


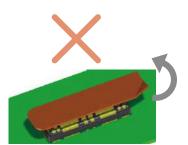


3.If the FPC does not have sufficient rigidity, solder stripping or connector breakage may occur.

Please use it after checking the repetitive operation with a flexible board in advance, such as during a trial manufacture run.

Refrain from holding the corner of the flexible board and removing it diagonally as it will result in a large load to the contacts.





## While Taking into Consideration

Specifications mentioned in this catalog are reference values.

When considering to order or use this product, please confirm the Drawing and Product Specifications sheets.

Use an appropriate cable when using the connector in combination with cables.

If considering usage of a non-specified cable, please contact your sales representative.

If assembly process is done by jigs & tools which are not identified by Hirose, assurance will not be given.

If considering usage for below mentioned applications, please contact your sales representative.

In cases where the application will demand a high level of reliability, such as automotive, medical instruments, public infrastructure, aerospace/ defense etc. Hirose must review before assurance of reliability can be given.